

119TH CONGRESS
2D SESSION

S. 4810

To establish a grant program for education related to semiconductor manufacturing and related industries.

IN THE SENATE OF THE UNITED STATES

JUNE 17, 2026

Mr. KELLY (for himself and Mr. BUDD) introduced the following bill; which was read twice and referred to the Committee on Commerce, Science, and Transportation

A BILL

To establish a grant program for education related to semiconductor manufacturing and related industries.

1 *Be it enacted by the Senate and House of Representa-*
2 *tives of the United States of America in Congress assembled,*

3 **SECTION 1. SHORT TITLE.**

4 This Act may be cited as the “CHIPS Training in
5 America Act of 2026”.

1 **SEC. 2. AUTHORIZATION FOR THE CREATING HELPFUL IN-**
 2 **CENTIVES TO PRODUCE SEMICONDUCTORS**
 3 **(CHIPS) FOR AMERICA WORKFORCE AND**
 4 **EDUCATION FUND.**

5 Section 102(d) of Public Law 117–167 (commonly
 6 known as the “CHIPS and Science Act of 2022”) is
 7 amended in paragraph (1) by inserting “, including estab-
 8 lishment and maintenance of a single publicly accessible
 9 online clearinghouse of microelectronics education and
 10 workforce development information” before the period at
 11 the end of the paragraph.

12 **SEC. 3. AUTHORIZATION OF NATIONAL SEMICONDUCTOR**
 13 **TECHNOLOGY CENTER ACTIVITIES.**

14 Section 9906(c)(2) of the William M. (Mac) Thorn-
 15 berry National Defense Authorization Act for Fiscal Year
 16 2021 (15 U.S.C. 4656(c)(2)) is amended in subparagraph
 17 (C)—

18 (1) in clause (i), by striking “and” after the
 19 semicolon;

20 (2) in clause (ii), by striking the period at the
 21 end and inserting “; and”; and

22 (3) by adding at the end the following:

23 “(iii) the development of competency-
 24 based degree, credentialing, and certificate
 25 frameworks to increase standardization

1 within semiconductor and microelectronics
2 workforce development programs.”.

3 **SEC. 4. NATIONAL STRATEGY ON MICROELECTRONICS**
4 **WORKFORCE.**

5 Section 9906(a) of the William M. (Mac) Thornberry
6 National Defense Authorization Act for Fiscal Year 2021
7 (15 U.S.C. 4656(a)) is amended—

8 (1) in paragraph (2)—

9 (A) by redesignating subparagraph (I) as
10 subparagraph (J); and

11 (B) by inserting after subparagraph (H)
12 the following:

13 “(I) For purposes of the duties described
14 in subparagraph (D) of paragraph (3) only, the
15 Secretary of Labor, the Secretary of Education,
16 and the Secretary of Veterans Affairs.”.

17 (2) in paragraph (3), by inserting after sub-
18 paragraph (C) the following:

19 “(D) NATIONAL STRATEGY ON MICRO-
20 ELECTRONICS WORKFORCE.—

21 “(i) IN GENERAL.—

22 “(I) NATIONAL STRATEGY ON
23 MICROELECTRONICS WORKFORCE DE-
24 VELOPMENT.—Not later than 1 year
25 after the date of enactment of the

1 CHIPS Training in America Act of
2 2026, in consultation with appropriate
3 stakeholders in the microelectronics
4 industry, relevant researchers or ex-
5 perts at institutions of higher edu-
6 cation, economic development organi-
7 zations, and other apposite stake-
8 holders, the Subcommittee shall de-
9 velop a 5-year national strategy on
10 microelectronics workforce develop-
11 ment.

12 “(II) ADDITIONAL SUB-
13 COMMITTEE MEMBERS.—For the pur-
14 poses of this subparagraph only such
15 Subcommittee shall also include the
16 Secretary of Labor, the Secretary of
17 Education, and the Secretary of Vet-
18 erans Affairs.

19 “(ii) ELEMENTS.—The strategy devel-
20 oped under this subparagraph shall—

21 “(I) specify and prioritize annual
22 and long-term objectives, including
23 the role of each agency in supporting
24 programs and activities designed to
25 meet the objectives, to ensure a ro-

1 bust, skilled domestic microelectronics
2 workforce;

3 “(II) specify the common metrics
4 that will be used to assess progress
5 toward achieving the objectives;

6 “(III) describe the roles of and
7 means of coordination with elemen-
8 tary and secondary, and postsec-
9 ondary, education systems in achiev-
10 ing the objectives;

11 “(IV) describe how Federal fund-
12 ing will be used to support the strat-
13 egy’s microelectronics workforce ini-
14 tiatives;

15 “(V) describe the approaches to
16 be taken by each participating agency
17 to assess the effectiveness of the agen-
18 cy’s microelectronics workforce pro-
19 grams and activities;

20 “(VI) describe how objectives
21 outlined in the strategic plan will
22 align with investments made using
23 funds from divisions A and B of Pub-
24 lic Law 117–167 (commonly known as

1 the ‘CHIPS and Science Act of
2 2022’);

3 “(VII) describe how objectives
4 outlined in the strategic plan will
5 align with the objectives of the 5-year
6 STEM education strategic plan re-
7 quired under section 101 of the Amer-
8 ica COMPETES Reauthorization Act
9 of 2010 (42 U.S.C. 6621); and

10 “(VIII) describe how objectives
11 outlined in the strategic plan will
12 align with the objectives of the na-
13 tional strategy on microelectronics re-
14 search, as required under subpara-
15 graph (A), as applicable.

16 “(iii) FOSTERING COORDINATION OF
17 WORKFORCE PROGRAMS.—The Sub-
18 committee shall coordinate programs and
19 activities of Federal agencies relating to
20 microelectronics workforce development,
21 and ensure such programs and activities
22 are consistent with the strategy required
23 under this subparagraph.

1 “(iv) REPORTING AND UPDATES.—

2 Not less frequently than once every 5
3 years, the Subcommittee shall—

4 “(I) update the strategy under
5 this subparagraph;

6 “(II) submit the revised strategy
7 to the appropriate committees of Con-
8 gress; and

9 “(III) make such strategy pub-
10 licly available through the online
11 clearinghouse authorized in section
12 102(d) of Public Law 117–167.”.

13 **SEC. 5. GRANT PROGRAM FOR EDUCATION RELATED TO**
14 **SEMICONDUCTOR MANUFACTURING AND RE-**
15 **LATED INDUSTRIES.**

16 Division H of title XCIX of the William M. (Mac)
17 Thornberry National Defense Authorization Act for Fiscal
18 Year 2021 (15 U.S.C. 4651 et seq.) is amended by insert-
19 ing after section 9906 the following:

20 **“SEC. 9906A. WORKFORCE DEVELOPMENT ACTIVITIES.**

21 “(a) DEFINITIONS.—In this section:

22 “(1) ELIGIBLE INSTITUTION.—The term ‘eligi-
23 ble institution’ means—

24 “(A) an institution of higher education, as
25 defined in section 101 of the Higher Education

1 Act of 1965 (20 U.S.C. 1001), at which the
 2 highest degree predominantly awarded to stu-
 3 dents is not a baccalaureate degree or higher
 4 degree;

5 “(B) a postsecondary vocational institu-
 6 tion, as defined in section 102(c) of the Higher
 7 Education Act of 1965 (20 U.S.C. 1002(c));
 8 and

9 “(C) an area career and technical edu-
 10 cation school, as defined in subparagraphs (A)
 11 or (B) of section 3(3) of the Carl D. Perkins
 12 Career and Technical Education Act of 2006
 13 (20 U.S.C. 2302(3)).

14 “(2) ELIGIBLE PARTNERSHIP.—The term ‘eligi-
 15 ble partnership’ means a partnership that—

16 “(A) includes—

17 “(i) an eligible institution;

18 “(ii) a covered entity; and

19 “(iii) a State, Indian Tribe, or polit-
 20 ical subdivision thereof; and

21 “(B) may include other entities.

22 “(3) NATIONAL SEMICONDUCTOR TECHNOLOGY
 23 CENTER.—The term ‘National Semiconductor Tech-
 24 nology Center’ means the entity established under
 25 section 9906(c).

1 “(b) GRANTS AUTHORIZED.—The National Semicon-
2 ductor Technology Center shall make awards, on a com-
3 petitive basis, to eligible partnerships to establish or ex-
4 pand workforce development and academic programs of-
5 fered by an eligible institution (which may include short-
6 term programs or non-credit programs offered by that eli-
7 gible institution), related to semiconductor manufacturing
8 and related equipment, materials, advanced packaging,
9 microelectronics, computer science, engineering, and re-
10 lated industries.

11 “(c) APPLICATION.—An eligible partnership desiring
12 a grant under this section shall submit an application to
13 the National Semiconductor Technology Center at such
14 time, in such manner, and containing such information as
15 the National Semiconductor Technology Center may re-
16 quire. The application shall require—

17 “(1) a description of the eligible partnership;

18 “(2) a description of the workforce needs that
19 will be addressed through the activities funded by
20 the grant;

21 “(3) a description of the eligible partnership’s
22 strategy to sustain such activities after the grant pe-
23 riod;

24 “(4) a description of how the eligible partner-
25 ship will recruit and retain individuals with barriers

1 to employment (as defined in section 3 of the Work-
2 force Innovation and Opportunity Act definition (29
3 U.S.C. 3102)) in programs that receive grant fund-
4 ing; and

5 “(5) a description of how programs supported
6 by grants under this subsection align with the work-
7 force pathways and credential frameworks estab-
8 lished by the National Semiconductor Technology
9 Center or the National Science Foundation.

10 “(d) SELECTION.—In selecting eligible partnerships
11 to receive a grant under this section, the National Semi-
12 conductor Technology Center shall give priority to eligible
13 partnerships located in areas with growing microelec-
14 tronics ecosystems, as determined by the National Semi-
15 conductor Technology Center, that serve or intend to serve
16 as members of broader sectoral partnerships and coordi-
17 nate with State and local workforce development boards
18 (as established under sections 101 and 107 of the Work-
19 force Innovation and Opportunity Act (29 U.S.C. 3111;
20 29 U.S.C. 3122)), respectively.

21 “(e) AMOUNT; DURATION.—

22 “(1) AMOUNT.—A grant awarded under this
23 section shall be for an amount equal to or less than
24 \$7,000,000.

1 “(2) DURATION.—A grant awarded under this
2 section shall be for a period not to exceed 5 years.

3 “(f) FEDERAL COST SHARE.—

4 “(1) MAXIMUM FEDERAL SHARE.—The Federal
5 share of the costs of a grant under this section shall
6 not exceed 50 percent of such costs.

7 “(2) REQUIRED WORKER AND COMMUNITY IN-
8 VESTMENTS.—Non-Federal costs contributed by a
9 covered entity under this section shall be considered
10 as part of an eligible entity’s commitments to worker
11 and community investments as required under sec-
12 tion 9902(a)(2)(B)(ii)(II).

13 “(g) REPORT.—

14 “(1) REPORT TO THE NATIONAL SEMICON-
15 DUCTOR TECHNOLOGY CENTER.—Each eligible part-
16 nership receiving a grant under this section shall
17 prepare and submit an annual report to the National
18 Semiconductor Technology Center that contains in-
19 formation about each of the following with respect to
20 individuals participating in a program funded by a
21 grant under this section:

22 “(A) The total number of participants,
23 disaggregated by sex, race, and ethnicity.

24 “(B) The total number of participants who
25 completed the program.

1 “(C) The indicators required by section
2 116(b)(2)(A)(i) of the Workforce Innovation
3 and Opportunity Act (29 U.S.C.
4 3141(b)(2)(A)(i)).

5 “(2) REPORT TO CONGRESS.—Not later than
6 180 days of receiving the annual report under para-
7 graph (1), the National Semiconductor Technology
8 Center shall—

9 “(A) prepare and submit a report con-
10 taining a summary of the information described
11 in paragraph (1) to the Committee on Com-
12 merce, Science, and Transportation and the
13 Committee on Health, Education, Labor, and
14 Pensions of the Senate and the Committee on
15 Science, Space, and Technology and the Com-
16 mittee on Education and Workforce of the
17 House of Representatives; and

18 “(B) make such report publicly available.

19 “(h) AUTHORIZATION OF APPROPRIATIONS.—Not-
20 withstanding subsection (d) of section 102 of Public Law
21 117–167 (commonly known as the ‘CHIPS and Science
22 Act of 2022’), amounts made available under subpara-
23 graphs (D) and (E) of subsection (d)(2) of such section
24 shall be used to carry out this section for the applicable

1 fiscal year, and paragraph (3) of section 102(d) of Public
2 Law 117–167 shall not apply.”.

3 **SEC. 6. PROHIBITION ON ADDITIONAL MICROELECTRONICS**
4 **EDUCATION AND WORKFORCE CLEARING-**
5 **HOUSE.**

6 A Federal agency shall not establish a microelec-
7 tronics education and workforce clearinghouse that is du-
8 plicative or alternative to the online clearinghouse author-
9 ized in section 102(d) of Public Law 117–167 (commonly
10 known as the “CHIPS and Science Act of 2022”).

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